

UNISONIC TECHNOLOGIES CO., LTD

5N50 Power MOSFET

5A, 500V N-CHANNEL POWER MOSFET

DESCRIPTION

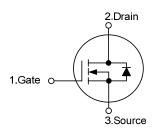
The UTC **5N50** is an N-channel power MOSFET adopting UTC's advanced technology to provide customers with DMOS, planar stripe technology. This technology is designed to meet the requirements of the minimum on-state resistance and perfect switching performance. It also can withstand high energy pulse in the avalanche and communication mode.

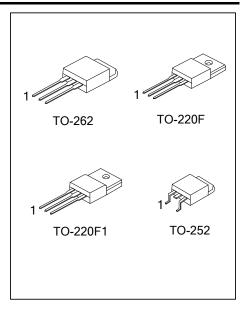
The UTC **5N50** can be used in applications, such as active power factor correction, high efficiency switched mode power supplies, electronic lamp ballasts based on half bridge topology.

■ FEATURES

- * $R_{DS(ON)}$ < 1.4 Ω @ V_{GS} = 10 V, I_D =2.5 A
- * 100% avalanche tested
- * High switching speed

■ SYMBOL

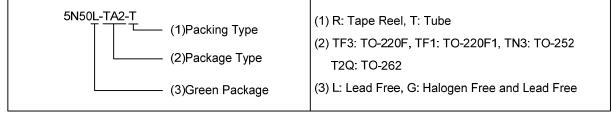




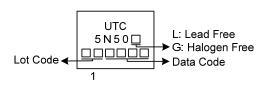
■ ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
5N50L-TF3-T	5N50G-TF3-T	5N50G-TF3-T TO-220F		D	S	Tube	
5N50L-TF1-T	5N50G-TF1-T	TO-220F1	G	D	S	Tube	
5N50L-TN3-R	5N50G-TN3-R	TO-252	G	D	S	Tape Reel	
5N50L-T2Q-T	5N50G-T2Q-T	TO-262	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



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■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	500	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I _D	5	А
	Pulsed (Note 2)	I _{DM}	20	А
Avalanche Current (Note 2)		I _{AR}	5	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	300	mJ
	Repetitive (Note 2)	E _{AR}	7.3	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-262		125	W
	TO-220F/TO-220F1	P _D	38	W
	TO-252		54	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 21.5mH, I_{AS} = 5A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. $I_{SD} \le 5A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-262/TO-220F TO-220F1	θја	62.5	°C/W
	TO-252		110	°C/W
Junction to Case	TO-262	θ _{JC}	1	°C/W
	TO-220F/TO-220F1		3.25	°C/W
	TO-251		2.13	°C/W

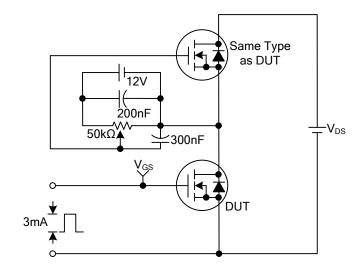
■ **ELECTRICAL CHARACTERISTICS** (T_C=25°C, unless otherwise specified)

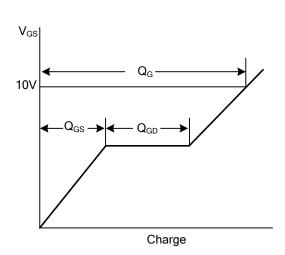
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	500			V
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	Reference to 25°C, I _D =250µA		0.5		V/°C
Drain Course Leakers Current			V _{DS} =500V, V _{GS} =0V			1	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =400V, T _C =125°C		10		μΑ
Gate- Source Leakage Current	Forward	- I _{GSS}	V_{GS} =30V, V_{DS} =0V			100	nA
	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Re	Static Drain-Source On-State Resistance		V _{GS} =10V, I _D =2.5A			1.4	Ω
DYNAMIC PARAMETERS		_				=.	
Input Capacitance		C _{ISS}	V 0V V 05V		535	625	pF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		70	105	pF
Reverse Transfer Capacitance		C_{RSS}	71=1.0lviH2		17	20	pF
SWITCHING PARAMETERS		_				=.	
Turn-ON Delay Time		t _{D(ON)}			30	45	ns
Rise Time		t_R	V_{DD} =30V, I_{D} =0.5A,		50	70	ns
Turn-OFF Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		145	165	ns
Fall-Time		t_{F}			72	105	ns
Total Gate Charge		Q_G	V 40V V 50V		20	24	nC
Gate to Source Charge		Q_GS	V_{GS} =10V, V_{DS} =50V, I_{D} =1.3A, I_{G} =100 μ A (Note 1, 2)		4		nC
Gate to Drain Charge		Q_{GD}	I _D =1.3A, I _G =100μA (Note 1, 2)		5		nC
SOURCE- DRAIN DIODE RATII	NGS AND CH	HARACTERIST	TICS				
Maximum Continuous Drain-Source Diode						5	Α
Forward Current		I _S				5	^
Maximum Pulsed Drain-Source Diode		I _{SM}				20	Α
Forward Current						20	^
Drain-Source Diode Forward Voltage		V_{SD}	I _S =5A, V _{GS} =0V			1.4	V

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

^{2.} Essentially independent of operating temperature

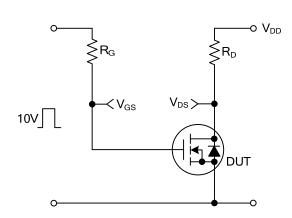
■ TEST CIRCUITS AND WAVEFORMS



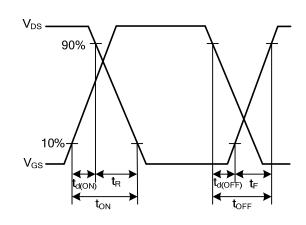


Gate Charge Test Circuit

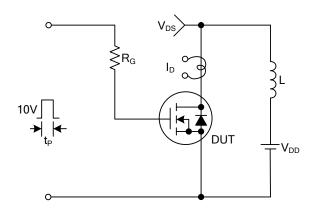
Gate Charge Waveforms



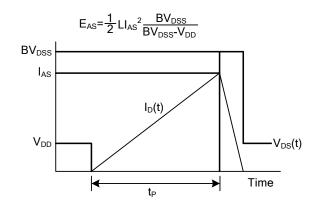




Resistive Switching Waveforms

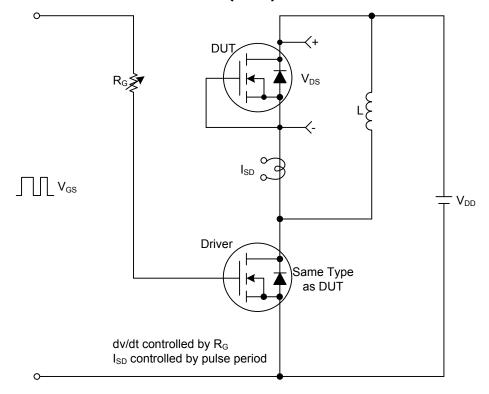


Unclamped Inductive Switching Test Circuit

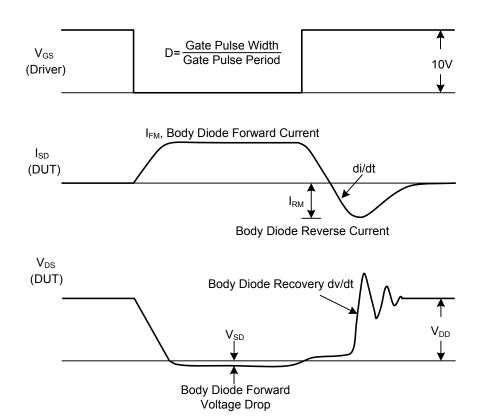


Unclamped Inductive Switching Waveforms

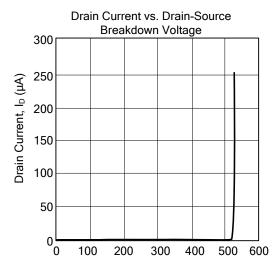
■ TEST CIRCUITS AND WAVEFORMS(Cont.)



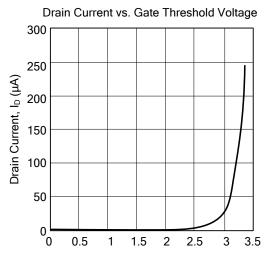
Peak Diode Recovery dv/dt Test Circuit & Waveforms



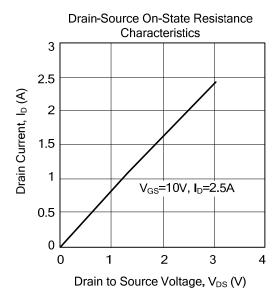
■ TYPICAL CHARACTERISTICS

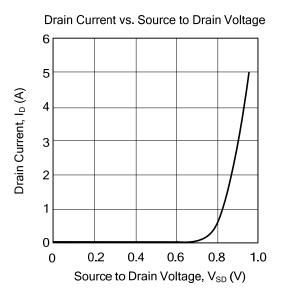


Drain-Source Breakdown Voltage, BV_{DSS} (V)



Gate Threshold Voltage, V_{TH} (V)





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